## Steps on current-voltage characteristics of a silicon quantum dot covered by natural oxide

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C onsidering a double-barrier structure form ed by a silicon quantum dot covered by natural oxide with two m etallic term in als, we derive simple conditions for a step-like voltage-current curve. Due to standard chem ical properties, doping phosphorus atom s located in a certain dom ain of the dot form geom etrically parallel current channels. The height of the current step typically equals to N 12 pA, where N = 0;1;2;3::: is the num ber of doping atom s inside the dom ain, and only negligibly depends on the actual position of the dopants. The found conditions are feasible in experimentally available structures.

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The fabrication of S i nanostructures became possible through recently developed new technologies [1, 2]. Individual silicon quantum dots (SQD) reported in [2] are spherical S i particles with diameters d in the range 5 { 12 nm covered by a 1 { 2 nm -thick natural S iO  $_2$  lm . M etallic current term in also ade from degenerately doped S i are de ned lithographically to touch each individual dot from above and from below.

To ensure m etallic electrodes the donor concentration n should be n  $n_{\rm M \ ott}$ , where  $n_{\rm M \ ott} = 7.3$  $10^{17} \, {\rm cm}^{-3}$ . The critical concentration  $n_{\rm M \ ott}$  is de ned by the M ott criterion [4], introducing the transition to a m etallic type of conductivity in a sem iconductor at:

$$a_{\rm B}$$
  $(n_{\rm M,ott})^{1=3} = 0.27$ : (1)

where  $a_B$  is the Bohr radius of an electron bound to a donor inside the Sicrystal, in the case of phosphorusdonors  $a_B = 3 \text{ nm}$  [4].

As for the doping of the dot, the situation concerning a M ott transition in that small dots is much less trivial than the one described by Eq. (1). Let us consider dots with diam eters d = 10 nm form ed from n-doped Siwith n =  $n_{M \text{ ott}}$  as an illustrative example. Then each dot contains in average one donor. Note that we will consider degenerately n<sup>+</sup>-doped electrodes with n  $n_{M \text{ ott}}$  which ensures m etallic conduction up to the borders of the dot.

Real fabrication technology [2] provides a wafer with hundreds of SQ D s on it with current leads tow ands each individual SQ D .D ots in average have the same value of m ean dopant concentration n, which is determined by the parent material of bulk silicon the dots are form ed

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from . However, on the level of each individual SQD we will always have exactly integer number of doping atom s. If, as in the example above, the average number of dopants  $\overline{N_{tot}} = 1$  the actual number of donors in the dot can have values  $N_{tot} = 0;1;2;3;\ldots,w$  ith values larger than these very unlikely.

Our objective is to illustrate, that SQDs from the same wafer fall into several distinct sets of approxim ately the same conductance. The typical value of conductance for each set is nearly completely determ ined by the number N of donors present in a certain part of a SQD so that N labels each set of SQDs.

Sum m arizing the above, we need for a quantization of the conduction through a dot with N donors the following conditions:

Size d of the dot comparable with Bohr radius:  $2 < d=a_B < 5$ .

A verage doping n of the dot n d, leading to a mean number of dopants  $\overline{N_{tot}}$  1, so that  $N_{tot} = 0;1;2$  are the most probable con gurations of an individual SQD.

D oping of the electrodes  $g_1 = n_M \text{ ott}$ , so that current leads are perfectly m etallic.

D ot covered by an oxide layer thick enough to suppress ballistic transport through the dot.

In fact all these condition can be simultaneously satis ed for SQD fabricated with the method mentioned above [2].

M odel system . We use a simple model of a cubic SQD with d >  $2a_B$  (we will use d = 10 nm for

estimates), covered with an oxide layer with thickness = 2 nm, height [3] B = 3.15 eV and contacted with current term inals from left and from right. The x-axis is oriented from left to right along the current ow, as shown in Fig.1.

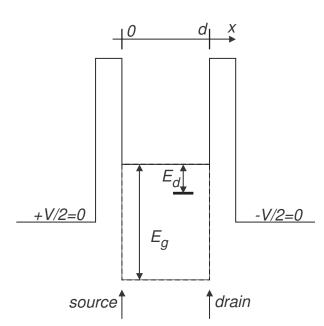


Fig.1. Potential pro le of the dot covered by an oxide layer at V = 0.A donor is marked with a short bar

A tunneling current is injected into the dot via the oxide barrier from the top (source at x = 0) and leaves the dot at the bottom (drain at x = d). Due to the presence of the oxide barriers this current is non-ballistic and non-therm al. We assume that the high potential barriers associated with the oxide layers are not much a ected by the voltage and the tunneling charges. We concentrate on what happens between these elective source and drain (Fig.2), as in [5].

In the case when the dot can be regarded as an insulating system it is reasonable to assume that the applied voltage equally drops over the potential barriers and the dots. For simplicity we neglect the dimension of the dimensional terms and the dot. In this approximation we can introduce an electric voltage  $V_{eff} = V (d 2) = d = 0.6 V$  describing the part of the total transport voltage V applied between electric source and drain which drops across the dot itself.

In this rude approximation we neglect the e ect of spatial quantization upon values on the ionization energy, the conductivity gap and material parameters of silicon.

D ot w ithout donors. At  $V_{eff} = 0$  the Ferm i level inside the dot is situated in the m iddle of the gap, i.e.

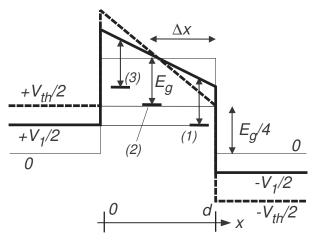


Fig2. Potential pro le of the dot between e ective source and drain biased with  $V_{eff} = V_1$  (thick solid line) and  $V_{eff} = V_{th}$  (dashed line)

 $\rm E_g=2$  below the conduction band edge (E  $_{\rm g}$  = 1:14 eV at 300 K).

As  $V_{eff}$  grows, the bottom of the (still empty) conduction band bends down accordingly. When the conduction band in the dot close to the drain aligns with the Ferm i level of the emitter we expect a drastic increase in the tunneling current. This threshold  $V_{th}$  voltage (Fig.2) for  $V_{eff}$  is given by  $V_{th} = E_g = (2e)$ , regardless of the number N tot of dopants in the dot (as long as the dot is not yet m etallic, of course). In the following we therefore limit our studies to voltages

$$V_{eff}$$
 j  $V_{th} = E_q = (2e) = 0.57V$ : (2)

In this voltage range we have a d-thick barrier (form ed by the dot) with always nite height between e ective source and drain. The intrinsic concentration of electrons and holes at 300 K is  $1.4 10^{10}$  cm<sup>-3</sup>. Even at this high tem perature the probability to have at least one intrinsic electron in a dot with size d = 10 nm is only  $1.4 10^8$ . So we would expect virtually no current in this mode. This is con rm ed by direct electrical tests [2] of SQD with the required properties.

Single-donor channel. Let us now consider one single donor in the dot located at x with ionization energy  $\beta E_d = 0.045 \text{ eV}$  (for P as a donor).

At zero tem perature current is due to resonant tunneling via non-ionized donor (as in [6] for exam ple). D ifferential conductance g (") for the states with energy " is

$$g(") = \frac{4e^2}{\sim} \frac{r}{(" - r_d)^2 + (r_d + r_r)^2};$$
 (3)

where  $\gamma_{r}$  is linew idth of 1s state of electron bound to the donor due to coherent m ixing with conduction states to the left (right) of the left (right) tunnel barrier.

O xide barriers (with height B = 3:15 eV and width = 2 nm) give dom inant contribution to  $\gamma_r$  compared to contribution of the body of the dot (with typical height < E<sub>g</sub>=2 = 0:57 eV and width < d = 10 nm). So, we can approximate  $\gamma_r$  with linewidth for the case of an impurity localized at distance inside rectangular one-dimensional tunnel burrier [6] of height B:

$$r = r = \frac{2p_F}{p_F^2 + 2} B \frac{\exp(2)}{\exp(2)} = 2.5 \quad 10^9 \text{ eV};$$
(4)

where m is (true, not e ective) electron mass, =  $(2m B)^{1=2} = ~$ , and  $p_F = (2m E_F)^{1=2} = ~ 3^2 n_{el}^{1=3}$  is Ferm i wave number in the contact electrodes. The numerical estimate in (4) is given for the electrodes doped up to  $n_{el} = 10^{21}$  cm<sup>3</sup> as in [2].

W ithin approximation (4) point " = " $_d$  brings function g(") given by (3) to a sharp maximum g(" $_d$ ) =  $e^2 = \sim ofwidth$  V<sub>t</sub>h.

From Fig2 it is clear that resonant energy  $"_d = E_g=2 \quad xV_{eff}=(2ed) \quad E_d$ . This means that as soon as e ective Ferm i level  $eV_{eff}=2$  reaches a certain threshold  $eV_1=2$ , tunnel current J owing through the structure acquires a step-like increase of

$$J_{1} = \frac{1}{e} \int_{eV=2}^{Z} g(")d" = \frac{g("_{d})2}{e} = \frac{2e}{\sim} = 12pA;$$
(5)

If the impurity is located near the drain, i.e.  $d_{a} < x < d$  (as donor 1 in Fig.2), then threshold  $V_1$  for the electric voltage  $V_{eff}$  is given by

$$V_1 = E_q = (2e)$$
  $E_d = e = 0.525V$ : (6)

In contrast, for an impurity located at distances  $x > 2dE_{d}=E_{g}$  from the drain (i.e. further away than the threshold case of donor 2 in Fig.2), no additional current channel via a single impurity can be opened at low enough voltages de ned in (2) where virtually no background current is present. In the present case this value x = 0.8 nm, which returns us to the above criterion: only impurities located in the immediate vicinity (de ned within the accuracy  $a_{B}$ ) of the drain contribute to the single-impurity channel.

This shows that in stapproximation the conductance of this channel does not depend on x. As shown above, a single-im purity channel already only selects in purities located within a very narrow range of x close to the drain.

Two-, three-, multi-donor channel. The above consideration shows, that due to the bend of the bottom of conduction band following the transport voltage, there is no chance to notice current owing through a sequential chain of impurities (such as donors 1 and 3 in Fig.2), connecting source and drain. The contribution of such a chain will be totally masked by the current owing directly via the conduction band. The only way for multiple in purities to manifest them selves in quantized conductance is to form multiple geom etrically parallel singe-impurity channels situated close enough to the drain as considered above.

Therefore, if N > 1 in purities fall into the thin layer near the drain to approximately the same x coordinate as that of donor 1 in Fig.2 (within the Bohr radius), we will see a switching-on of an N -fold channel with current

$$J_N = N J_1 = N 2e = N 12pA$$
 (7)

at the same threshold voltage  $V_{eff} = V_1 = 0.525 V$  as for a single-donor channel (Fig.3).

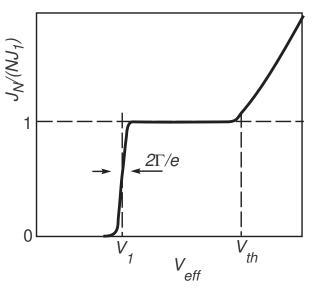


Fig.3. Current-voltage characteristics of a model system (not to scale)  $% \left( \left( {{{\left( {{{{{\bf{n}}}} \right)}_{{{\bf{n}}}}}_{{{\bf{n}}}}}} \right)_{{{\bf{n}}}} \right)$ 

A llthe above considerations are only valid as long as the dot itself can be regarded as an insulating system . As the number of donors in a SQD grows, the dot becomes a metallic particle, and the conduction band edge in the dot aligns with the Ferm i level of the electrodes. In a very simple estimate we de ne this transition to a metal when the total volume of N<sub>tot</sub> donors with an

individual volume of 4 = 3  $a_B^3$  exceeds the volume of the dot. This is an exaggerated version of the M ott criterion (1) which holds not only in bulk, but in a small structure, too. For the analyzed example from above this gives N<sub>tot</sub> = 8 as a limiting value. The practically interesting set 0;1;2;3;::: for both N<sub>tot</sub> and N considered above is still far below this limit.

Quite a number of other mechanisms of electron transport might take place in this system. Surprisingly, even taking into account such other mechanisms [7] does not change much the main idea of the present paper.

In small dots with diameter  $d < 2a_B = 6 nm$  the domain with N active dopants extends to the whole dot, and thus N = N<sub>tot</sub>. In large dots with diameter  $d > 2a_B = 6 nm$  the domain with active dopants is less than the dot itselfand is localized near the drain. Hence the position of the domain, number N and value  $J_N$  all can be di erent for the current owing in di erent directions. Really, when sign of applied voltage changes, the source and the drain change places.

In a certain sense the discrete increase of dot's conductivity which follow the increase of the dopants num – ber could be regarded as a m esoscopic analog of the M ott transition between insulating and conducting states of the system.

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